



MCS6.A

Description: NB-IoT / CAT M1 Low Profile 4G SMD Dielectric Antenna

Features:

GSM / CDMA / DCS / PCS / WCDMA / UMTS /HSDPA / GPRS / EDGE NB-IoT / CAT M1 Bands 698~960MHz / 1710~2690MHz High Efficiency Multi-Band SMD antenna Low profile 42*10*3mm RoHS & REACH Compliant



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Introduction

1.



The MCS6.A is a low profile SMD NB-IoT / CAT M1 Bands / 4G/3G/2G embedded antenna designed for direct SMD mount on a device PCB. It provides high efficiency in a very small form factor of just 42*10*3mm.

NB-IoT / CAT M1 is a low power wide area (LPWA) technology specifically designed for IoT and M2M. NB-IoT / CAT M1 technology offers lower maintenance cost, with greater efficiency and reliability by reducing power consumption and providing deeper penetration compared to standard cellular technologies. It operates on secure mobile networks making it suited to automotive, smart meter, medical and smart city applications.

If tuning is required, the MCS6.A can be tuned for the device environment without the need for new tooling. Its rectangular shape and very small size make it very easy to integrate. It is supplied on tape and reel ensuring that it can be mounted via pick and place to reflow solder directly on the edge of the PCB board.

This antenna is recommended to be used with longer ground-plane lengths of 120mm or more to attain its highest rated efficiency. Note the Return Loss and Efficiency graphs on Page 16.

Contact your regional Taoglas Customer Support Team for quick and professional support from our senior engineering team on integration and matching of the antenna to your device.



2. Specifications

			Elo	ectrical			
		E	Band 2	Ва	nd 4	Ban	d 12
Frequer	ncy (MHz)	Tx	Rx	Тх	Rx	Тх	Rx
		1850-	1930-1990	1710-1755	2110-2155	699-716	729-746
			Peal	k Gain (dBi)			
On Evalua	ation Board	2.76	3.26	3.11	3.75	-1.05	-0.02
			Avera	age Gain (dB)			
On Evalua	ation Board	-2.04	-1.67	-1.65	-1.85	-3.50	-2.25
			Effi	iciency (%)			
On Evalua	ation Board	62.46	67.47	68.33	65.67	44.58	59.60
			Retu	ırn Loss(dB)			
On Evaluation Board	Typical	<-10	<-10	<-10	<-10	<-10	<-10
On Evaluation Board	Band Edge	<-6	<-6	<-7	<-7	<-5	<-5
Impe	edance				50Ω		
Polar	ization				Linear		
Maximum	Input Power				5W		
			Me	chanical			
Antenna	Dimensions			42mn	n x 10mm x 3mm		
Ma	terial				FR4		
We	eight				2.50g		
Solder	ing Type			SMT	through Reflow		
			Envir	onmental			
Operation	Temperature			-2	40°C ~ +85°C		
Storage Temperature		-40°C ~ +85°C					
Moisture Sensitivity Level (MSL)		3 (168 Hours)					

*All measurements were done on 123*45mm Evaluation board with 100mm length ground plane.



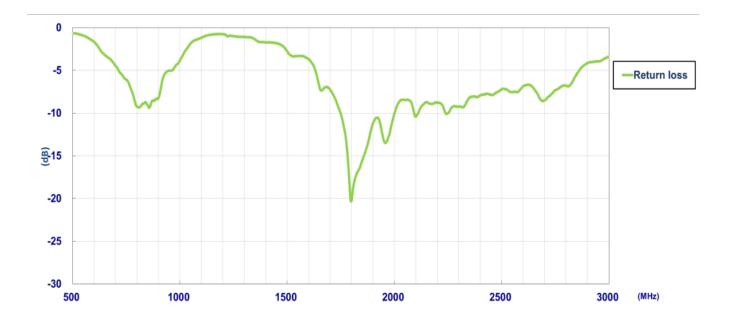
		5G/4G Bands	
Band Number	5GNR / FR1 / LTE / LTE-Advanced / WCDMA / HSPA / HSPA+ / TD-SCDMA		
	Uplink	Downlink	Covered
1	UL: 1920 to 1980	DL: 2110 to 2170	\checkmark
2	UL: 1850 to 1910	DL: 1930 to 1990	\checkmark
3	UL: 1710 to 1785	DL: 1805 to 1880	\checkmark
4	UL: 1710 to 1755	DL: 2110 to 2155	\checkmark
5	UL: 824 to 849	DL: 869 to 894	\checkmark
7	UL: 2500 to 2570	DL:2620 to 2690	\checkmark
8	UL: 880 to 915	DL: 925 to 960	\checkmark
9	UL: 1749.9 to 1784.9	DL: 1844.9 to 1879.9	\checkmark
11	UL: 1427.9 to 1447.9	DL: 1475.9 to 1495.9	\checkmark
12	UL: 699 to 716	DL: 729 to 746	\checkmark
13	UL: 777 to 787	DL: 746 to 756	\checkmark
14	UL: 788 to 798	DL: 758 to 768	\checkmark
17	UL: 704 to 716	DL: 734 to 746 (LTE only)	\checkmark
18	UL: 815 to 830	DL: 860 to 875 (LTE only)	\checkmark
19	UL: 830 to 845	DL: 875 to 890	\checkmark
20	UL: 832 to 862	DL: 791 to 821	\checkmark
21	UL: 1447.9 to 1462.9	DL: 1495.9 to 1510.9	\checkmark
22	UL: 3410 to 3490	DL: 3510 to 3590	\checkmark
23	UL:2000 to 2020	DL: 2180 to 2200 (LTE only)	\checkmark
24	UL:1625.5 to 1660.5	DL: 1525 to 1559 (LTE only)	\checkmark
25	UL: 1850 to 1915	DL: 1930 to 1995	\checkmark
26	UL: 814 to 849	DL: 859 to 894	\checkmark
27	UL: 807 to 824	DL: 852 to 869 (LTE only)	\checkmark
28	UL: 703 to 748	DL: 758 to 803 (LTE only)	\checkmark
29	UL: -	DL: 717 to 728 (LTE only)	\checkmark
30	UL: 2305 to 2315	DL: 2350 to 2360 (LTE only)	×
31	UL: 452.5 to 457.5	DL: 462.5 to 467.5 (LTE only)	×
32	UL: -	DL: 1452 - 1496	×
35		1850 to 1910	\checkmark
38		2570 to 2620	\checkmark
39		1880 to 1920	\checkmark
40		2300 to 2400	×
41		2496 to 2690	\checkmark
42		3400 to 3600	×
43		3600 to 3800	×
48		3550 to 3700	×
66	UL: 1710-1780	DL: 2110-2200	√
71		617 to 698	×
74/75/76		1427 to 1518	×
78		3300 to 3800	×
79	present Efficiency over 20%	4400 to 5000	×

*Covered Bands Represent Efficiency over 20%

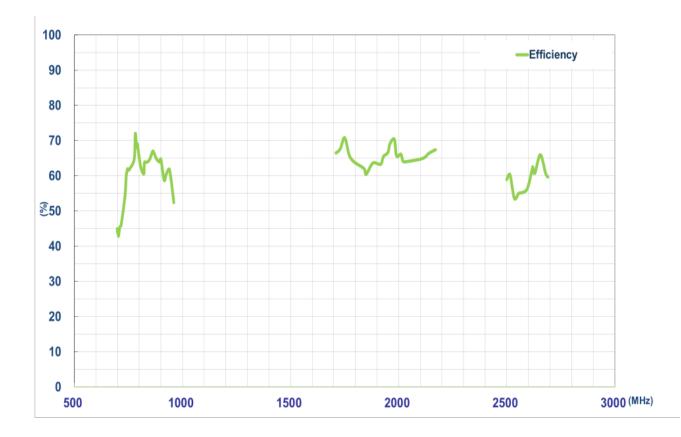




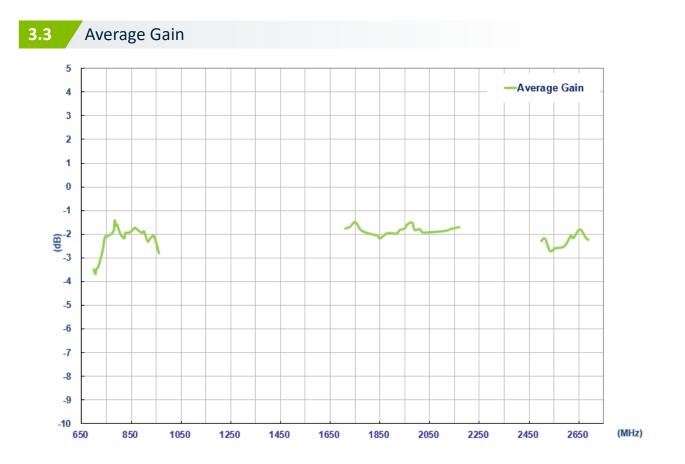
3.1 Return Loss

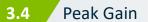


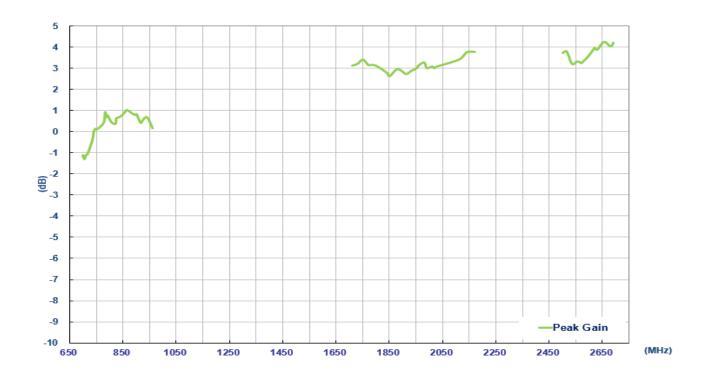
3.2 Efficiency





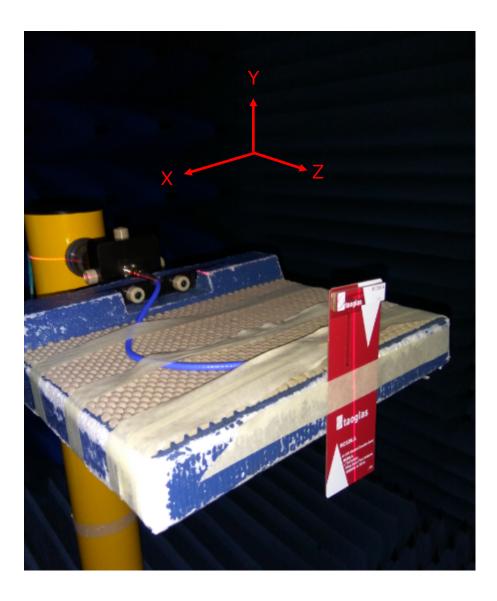








4.1 Test Setup

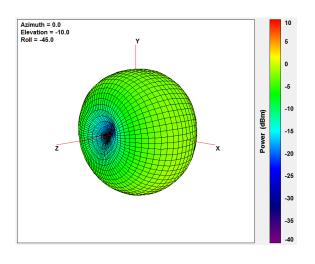


Free space

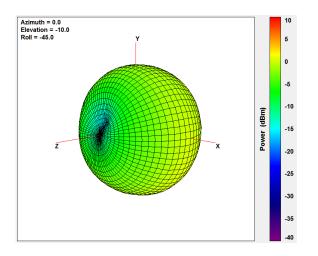


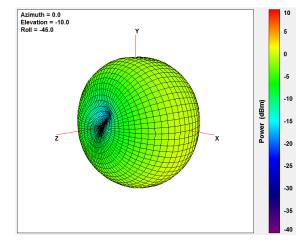


2D & 3D Radiation Patterns

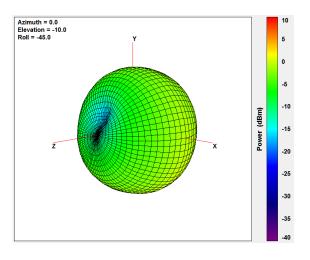


698MHz



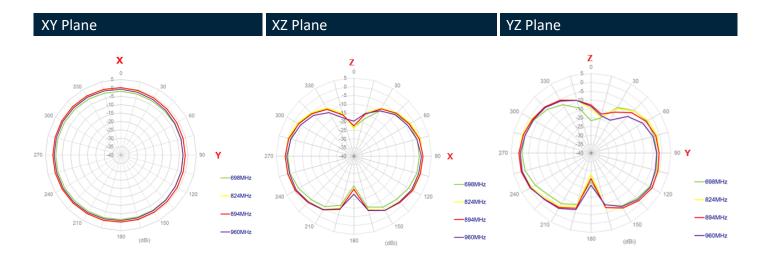


824MHz

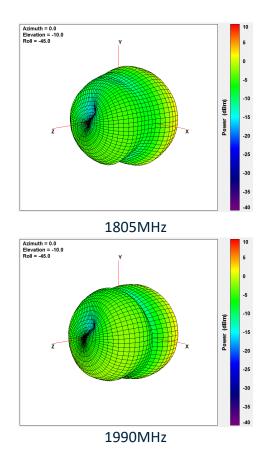


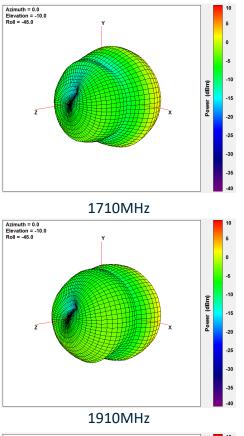
894MHz

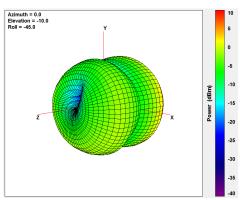
960MHz



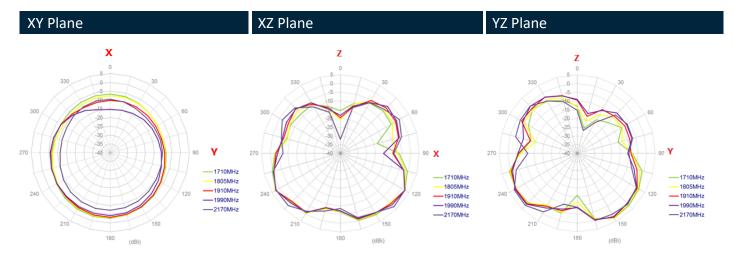














10

5

0

-5

-10

-15

-20

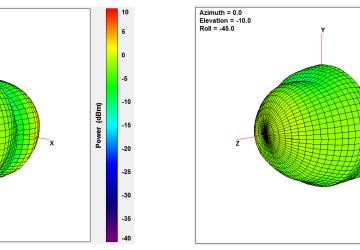
-25

-30

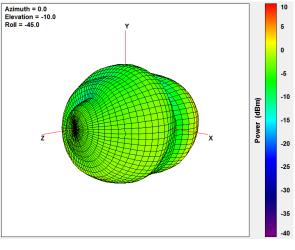
-35

-40

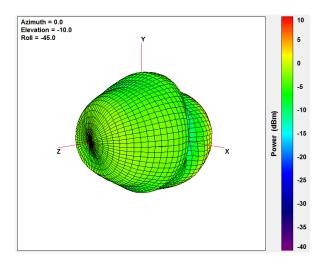
Power (dBm)



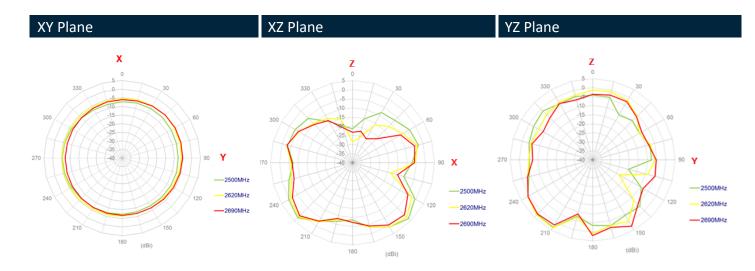
2620MHz



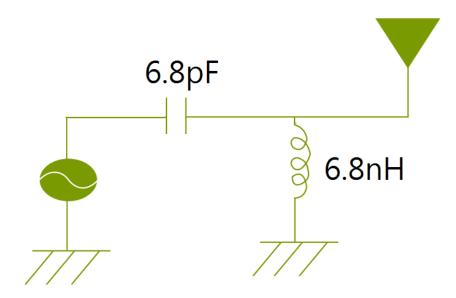
2500MHz







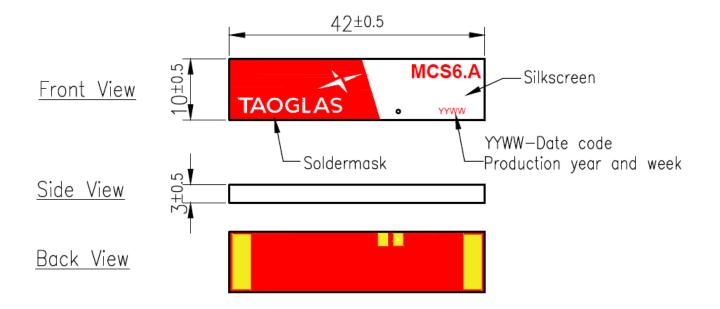






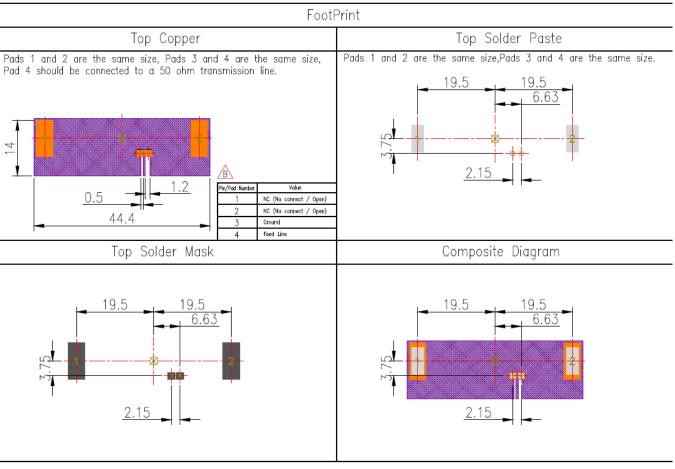








6.2 Footprint



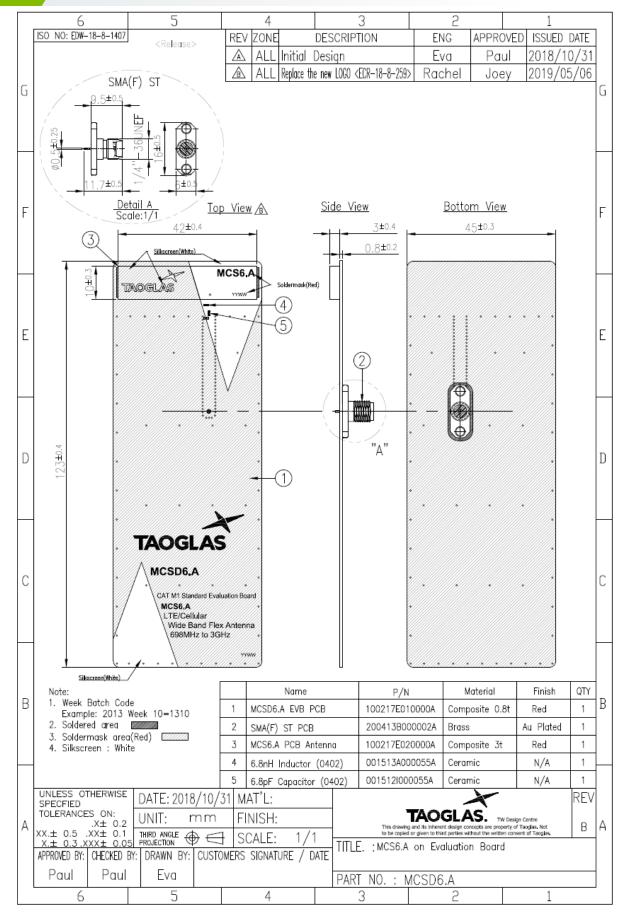
NOTE:

- 1. Au Plated area
- 2. Solder Mask area
- 3. Copper area
- 4. Paste area
- 5. Keepout Region area
- 6. Silkscreen
- 7. Soldermask

- 8. Ground keepout should extend through any inner PCB layers and any sides around the antenna till the board edge to minimize coupling from RF feed to around except the side facing system around
- ground, except the side facing system ground. 9. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow.
- 10. The dimension tolerances should follow standard PCB manufacturing guidelines.



6.3 Evaluation Board





7. Packaging

1000 pcs MCS6.A reel Dimensions - 330*330*60mm Weight - 2kg

1000 pcs MCS6.A / 1 Reel in small box Dimensions - 335*340*90mm Weight - 2.1Kg

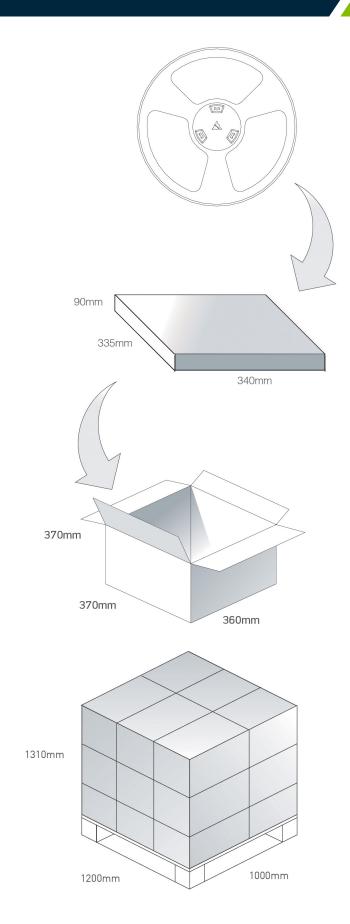
4 reels, 4000 pcs in one carton Carton Dimensions - 370*360*370mm Weight - 9.2Kg

Pallet Dimensions 1200*1000*1310mm

18 Cartons per Pallet

6 Cartons per layer

3 Layers

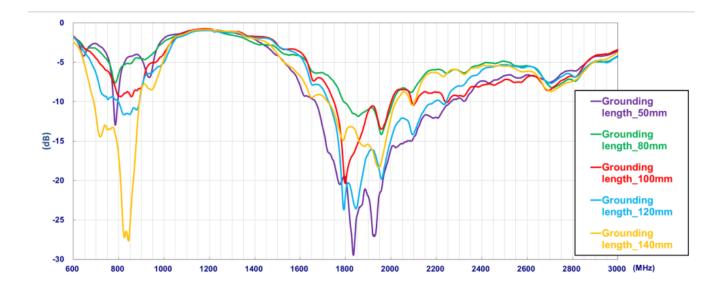


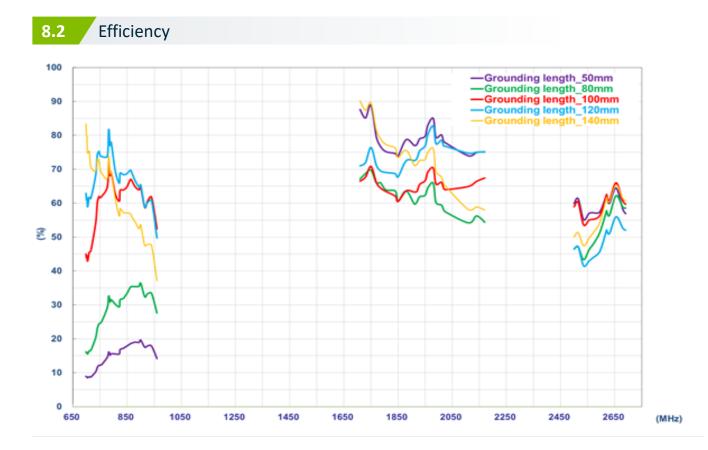


Application Note

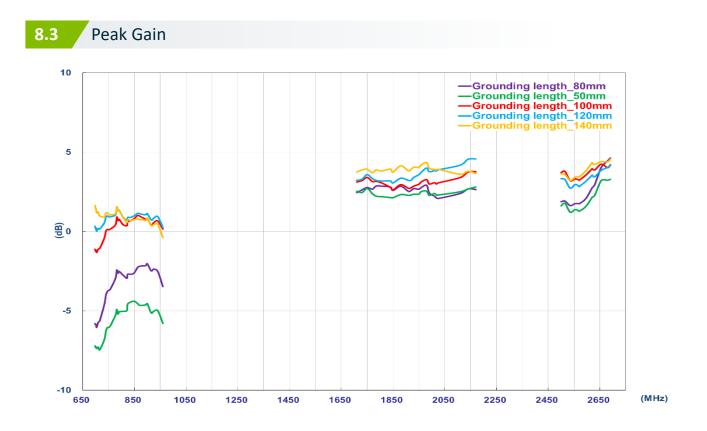


8.

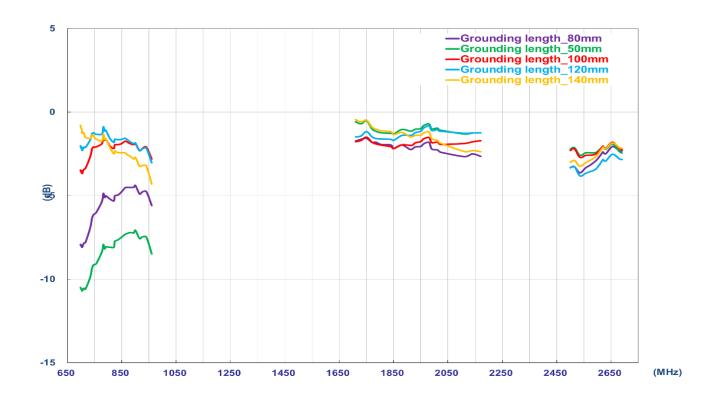














Changelog for the datasheet

SPE-17-8-036 - MCS6.A

Revision: E (Current	Version)
Date:	2021-09-14
Changes:	MSL, font and datasheet rev as it was listed as the "B" version.
Changes Made by:	Erik Landi

Previous Revisions

Revision: C		
Date:	2018-10-23	
Changes:	Pads Amended	
Changes Made by:	David Connolly	

Revision: B		
Date:	2017-08-08	
Changes:	Drawing Updated	
Changes Made by:	Andy Mahoney	

Revision: A (Original First Release)	
Date:	2017-08-10
Notes:	
Author:	Jack Conroy



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